



# OL-IP4855CX25

Wafer level chip-size package; 25 bumps; 2.01 x 2.01 x 0.66 mm

8 June 2017

Package information

## 1. Package summary

<b>Terminal position code</b>	B (bottom)
<b>Package type descriptive code</b>	WLCSP
<b>Package type industry code</b>	WLCSP
<b>Package style descriptive code</b>	UC (uncased chip)
<b>Package body material type</b>	X (other)
<b>Mounting method type</b>	S (surface mount)
<b>Issue date</b>	15-4-2013
<b>Manufacturer package code</b>	WLCSP25

Table 1. Package summary

Symbol	Parameter	Min	Typ	Nom	Max	Unit
D	package length	1.99	-	2.04	2.09	mm
E	package width	1.99	-	2.04	2.09	mm
A	seated height	0.44	-	0.47	0.5	mm
A <sub>2</sub>	package height	0.25	-	0.27	0.29	mm
e	nominal pitch	-	-	0.4	-	m
n <sub>2</sub>	actual quantity of termination	-	-	25	-	

## 2. Package outline

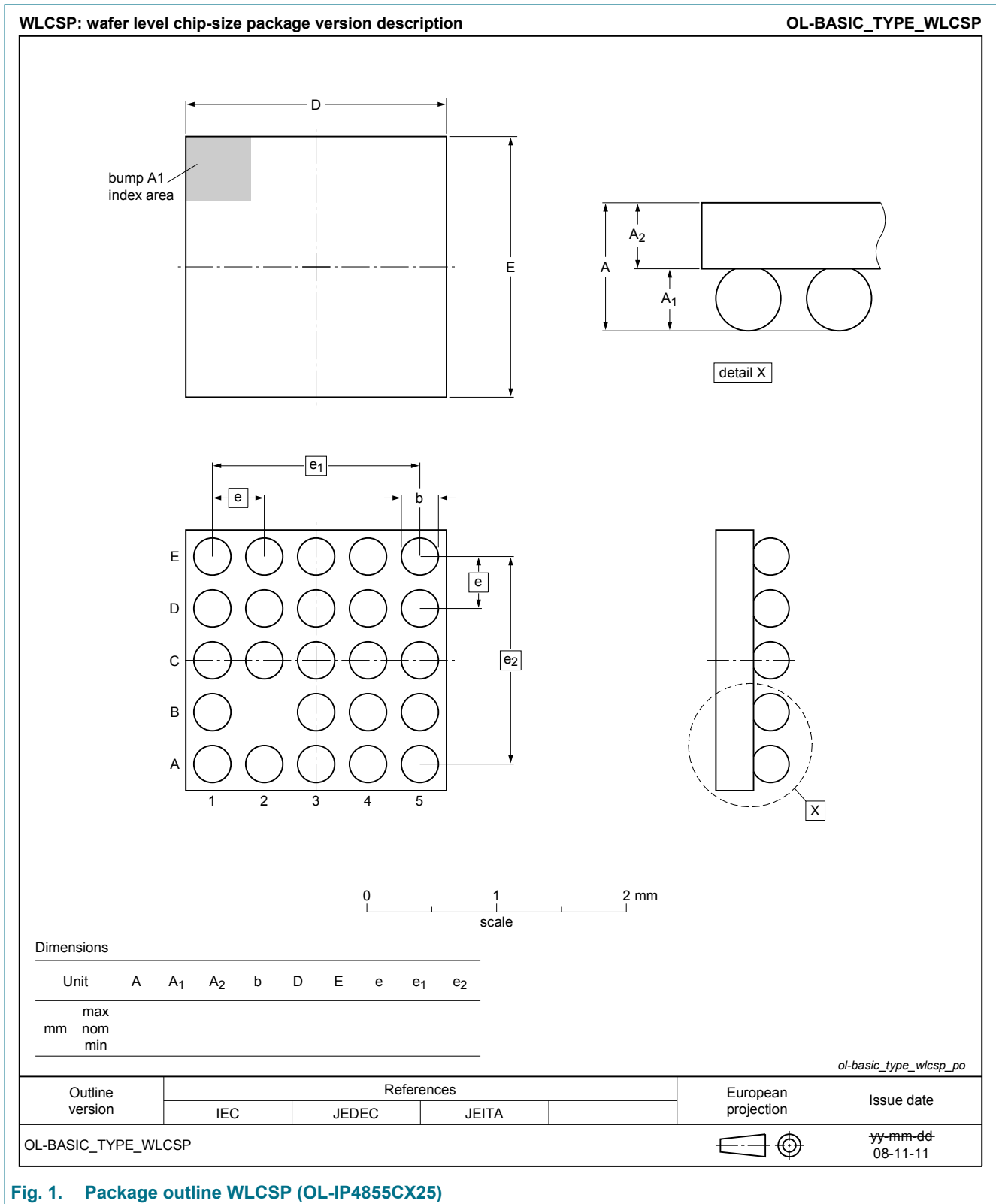


Fig. 1. Package outline WLCSP (OL-IP4855CX25)

### 3. Legal information

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